

## **Technical Data Sheet**

## DAIAMID® E75-K2 (Direct bonding with rubbers, TPUs)

Date: Mar 2013

Property		Norm	unit	value
Density	23C	ISO 1183	g/cm³	1.01
Tensile test Tensile strength at yield Tensile elongation at yield Tensile strength at break Tensile elongation at break	23C 50%Rh	ISO 527	MPa % MPa %	37 15 57 200<
E-Modulus (Tensile)	23C 50%Rh	ISO 527	MPa	1000
E-Modulus (Flexural)	23C 50%Rh	ISO 178	MPa	900
CHARPY impact strength	23C	ISO 179/1eU	kJ/m²	NB
CHARPY - Notched impact strength	23C	ISO 179/1eA	kJ/m²	10
Shore D hardness	D	ISO 868	-	74 - 76

The properties shown in this table are not a result of a statistical evaluation but were measured on one batch. Therefore the data must not be used as a basis for a specification.

Molding condi	ition	C1 C2	C3 A N	>	
C1 (C)	C2 (C)	C3 (C)	Adapter (C)	Nozzle (C)	Mold (C)
170 - 210	210 - 260	210 - 260	220 - 260	210 - 250	40 - 80

## **Drying condition**

- Drying of the granules is necessary only if the original packaging has been damaged or been left open for a long time.
- In these cases, the resins should be dried long enough to reduce the water content to less than 0.1%.
- Recommendation of dry condition is 70C or 80C  $\times$ 4hr